

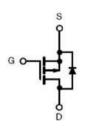
## MJ P-Channel Enhancement Mode Power MOSFET

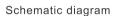
## Description

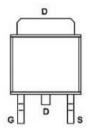
The MJ60P12K uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This device is well suited for use as a load switch or in PWM applications.

### General Features

- ◆ V<sub>DS</sub> =-60V,I<sub>D</sub> =-12A R<sub>DS(ON)</sub> <100mΩ @ V<sub>GS</sub>=-10V R<sub>DS(ON)</sub> <125mΩ @ V<sub>GS</sub>=-4.5V
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation





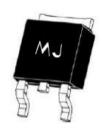


Application

High side switch for full bridge converter

◆ DC/DC converter for LCD display

Marking and pin assignment



TO-252-2L top view

## 100% UIS TESTED! 100% ΔVds TESTED!

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ60P12K	MJ60P12K	TO-252-2L	4	-	9

## Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ID	-12	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	-8.5	А
Pulsed Drain Current	Ідм	-30	А
Maximum Power Dissipation	Po	60	W
Derating factor		0.4	W/°C
Single pulse avalanche energy (Note 5)	Eas	50	mJ
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 175	°C

## Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	2.5	°C/W
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## Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V	-	-	-1	μA
Gate-Body Leakage Current	lgss	V <sub>DS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS</sub> (th)	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1	-1.5	-2.2	V
Drain-Source On-State Resistance	Rds(ON)	Vgs=-10V, lp=-12A	-	84	100	mΩ
Diani-Source Oir-State Resistance	TOS(ON)	Ves=-4.5V, ID=-8A	_	100	125	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-5V,I <sub>D</sub> =-12A	-	10	-	S
Dynamic Characteristics (Note 4)			ı	1		
Input Capacitance	Clss		-	1630.7	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =-30V,V <sub>GS</sub> =0V F=1.0MHz	-	90.6	-	PF
Reverse Transfer Capacitance	Crss	-	_	77.3	-	PF
Switching Characteristics (Note 4)	1					
Turn-on Delay Time	td(on)		-	11	-	nS
Turn-on Rise Time	tr	VDD=-30V, RL=1.5Ω	_	14	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =-10V,R <sub>G</sub> =3Ω	-	33	-	nS
Turn-Off Fall Time	tr - 13 -		nS			
Total Gate Charge	Qg		-	37.6	-	nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =-30V,I <sub>D</sub> =-12A V <sub>GS</sub> =-10V	-	4.3	-	nC
Gate-Drain Charge	Qgd	_	_	7.2	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsp	V <sub>GS</sub> =0V,I <sub>S</sub> =-12A	_	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-12	А
Reverse Recovery Time	covery Time t <sub>rr</sub> T <sub>J=25°C, IF=-12A</sub> - 35 -		nS			
Reverse Recovery Charge	I J=25°C, IF=-12A di/dt=-100A/μs <sup>(Note 3)</sup>		nC			
Forward Turn-On Time	ton	Intrinsic turn-on time is no	egligible(tu	ırn-on is do	ominated b	y LS+LD

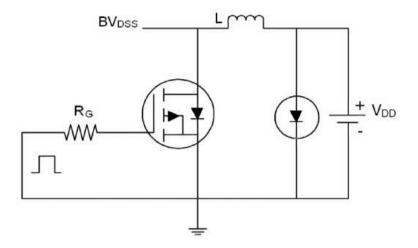
#### Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- (4) Guaranteed by design, not subject to production
- (§) EAS condition: Tj=25°C,  $V_{DD}$ =-20V,  $V_{G}$ =-10V, L=1mH, Rg=25 $\Omega$

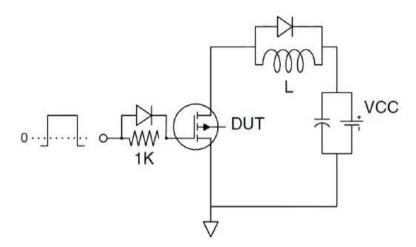




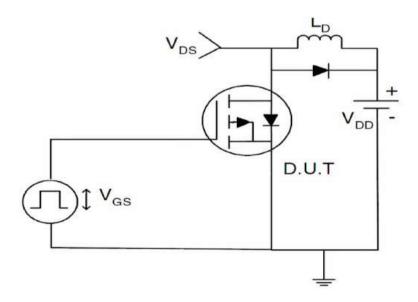
## Test circuit



Eas test Circuit



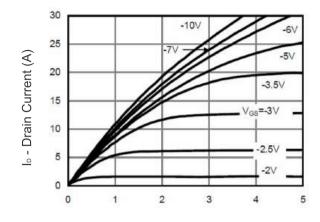
Gate charge test Circuit



Switch Time Test Circuit

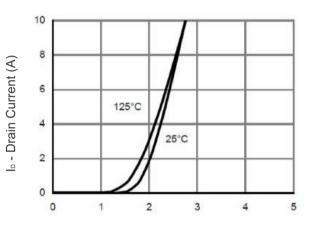


## Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)





Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

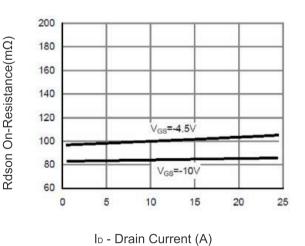
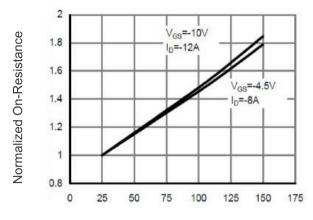
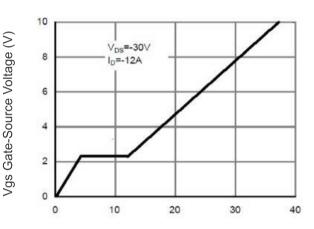


Figure 3 Rdson- Drain Current

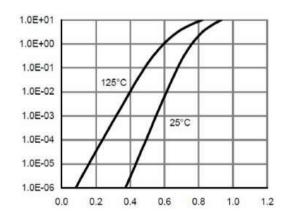


T<sub>J</sub> -Junction Temperature(°C)

## Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge



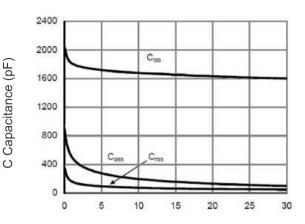
Vsd Source-Drain Voltage (V)

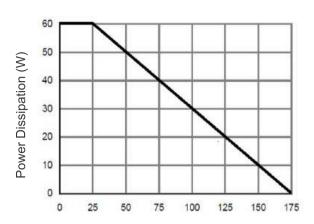
Figure 6 Source- Drain Diode Forward

Is - Reverse Drain Current (A)



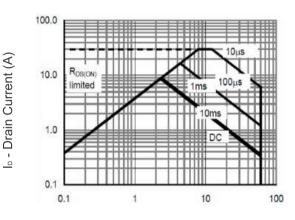


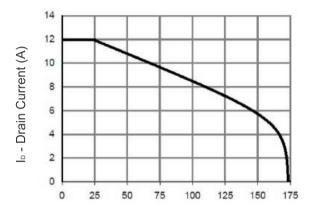




Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

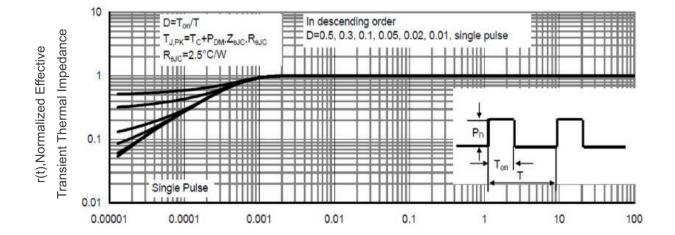
T<sub>J</sub> -Junction Temperature(°C)
Figure 9 Power De-rating





Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

T<sub>J</sub> -Junction Temperature(°C)
Figure 10 I<sub>D</sub> Current De-rating



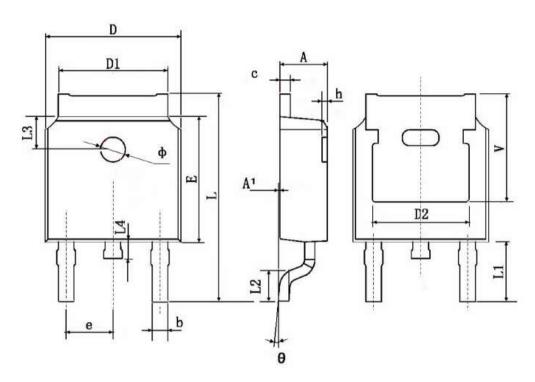
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





# TO-252 Package Information



Cumbal	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	00 TYP. 0.0		TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350	TYP.	0.211	TYP.



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